

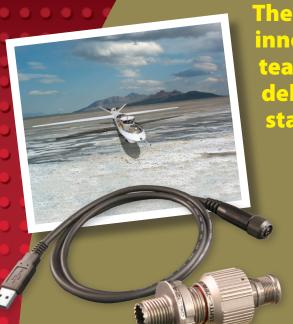
Glenair Interconnect Solutions Seminar Series

Free On-Site Technical Seminars from the Glenair Factory: Hosted Lunch-and-Learns on Key Interconnect Design Topics— From Weight Reduction and Miniaturization to EMI Filtering



Glenair Interconnect Solutions Seminar Series





The interconnect industry's most innovative engineering and design team is just a phone call away—ready to deliver the best technical seminar your staff will attend this year.

- Learn new ways to optimize interconnect system performance—from size and weight reduction to improved environmental sealing
- Take advantage of unprecedented face time with Glenair's application development and engineering team
- Walk away with all the samples, technical literature, and design ideas necessary to solve your toughest interconnect system challenges

Choose from the following eight seminars—or contact the factory to arrange a session tailored to meet your exact requirements.



Interconnect Seminar No. 1:

DESIGN INNOVATIONS GUARANTEED TO ADVANCE INTERCONNECT SYSTEM PERFORMANCE

This survey-level seminar covers:

- **Connector Miniaturization**
- System Weight Reduction
- EMI Filtering and Shielding
- Advanced Environmental Sealing
- High-Speed Interconnections



Interconnect Seminar No. 2:

COST-EFFECTIVE SIZE AND WEIGHT REDUCTION IN INTERCONNECT SYSTEMS

This in-depth seminar covers:

- Composite thermoplastics
- Micro-filament cable shield termination processes and technologies
- Connector Miniaturization
- Contact density optimization



Interconnect Seminar No. 3:

PROTECTING ELECTRONIC EQUIPMENT FROM COSTLY ENVIRONMENTAL DAMAGE WITH ADVANCED CONNECTOR SEALING TECHNOLOGIES

This in-depth seminar covers:

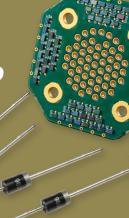
- Environmental connector classes and duties
- Materials selection for maximum durability
- Metal-to-glass hermetics
- Submersible/Marine solutions
- Accessory sealing solutions
- CBRN qualified components



FAST, EFFECTIVE AND PROVEN SOLUTIONS TO ELECTROMAGNETIC INTERFERENCE

This in-depth seminar covers:

- EMI/EMC Basics
- EMC Design Strategies and Solutions
- Cost Effective EMC Technologies
- Connector Filtering as a Design Solution
- EMP Connector and Box Solutions





Interconnect Seminar No. 5:

INTEGRATION OF ETHERNET AND OTHER HIGH-SPEED DATA BUS PROTOCOLS IN MISSION-CRITICAL APPLICATIONS

This survey-level seminar covers:



- Data bus protocols
- High-speed MS circulars
- USB/RJ field solutions
- Alternatives to standard ethernet connectors
- Optimizing contact/wire performance



OPTIMIZING BANDWIDTH, SPEED AND SECURITY WITH FIBER OPTIC TECHNOLOGIES

This in-depth seminar covers:

- Fiber optic data-link technology
- Singlemode vs. multimode
- Termini design protocols
- Fiber optic interconnect system design
- Innovation in expandedbeam systems



Interconnect Seminar No. 7:

DESIGNING PERFORMANCE INTO INTERCONNECT CABLES—FROM THE GROUND UP

This in-depth seminar covers:

- Factors that impact cable design and construction
- Strengths and weaknesses of available cable design options
- Practical application checklist for cable designers
- Glenair's cable design, construction and testing capabilities



Interconnect Seminar No. 8:

TAKING ADVANTAGES OF THE STRENGTHS AND WEAKNESSES OF COMPOSITE THERMOPLASTIC INTERCONNECT SYSTEMS

This in-depth seminar covers:

- Composite thermoplastic material science
- Weight savings and corrosion resistance
- Composite thermoplastics and lightning strike
- Qualifications and performance benchmarks
- Next-generation composite interconnect technologies



Contact your local Glenair sales group or visit www.glenair.com/seminars for more information. Seminars are offered on-site and/or at the Glenair factory.

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